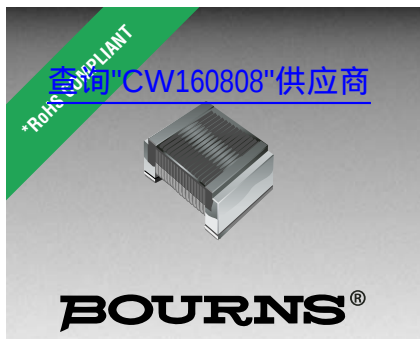




Features

- 0603 size
- Available in E12 series
- High Q up to 80 typ.
- High operating temperature of 125 °C
- Small size of only 1.6 mm
- Lead free

Applications

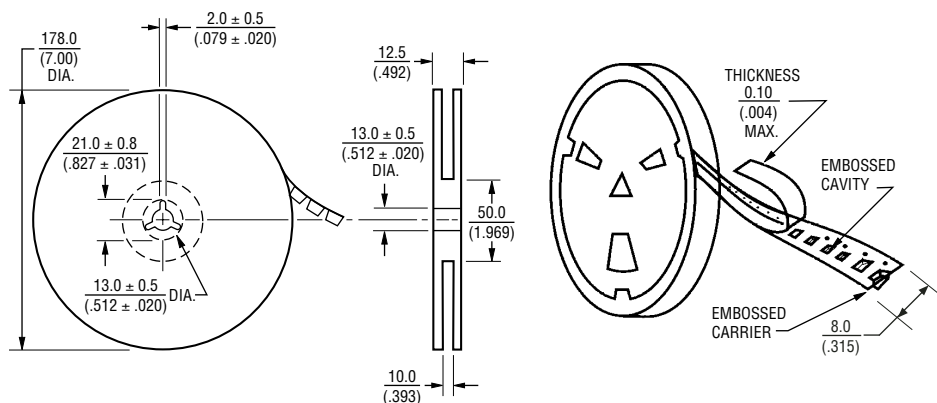
- Mobil phones
- Cellular phones
- CTV, VCR, HIC, FDD

CW160808 Series - High Q Chip Inductors

Electrical Specifications

Bourns Part No.	Inductance		Q	Test Freq. MHz		SRF min.	RDC	I rms
	nH	Tol. %	min.	L	Q	MHz	ohms	mA max.
CW160808-1N8M	1.8	±20	16	250	250	6000	0.04	700
CW160808-3N9K	3.9	±10	16	250	250	6000	0.08	700
CW160808-4N7K	4.7	±10	16	250	250	5800	0.10	700
CW160808-6N8J	6.8	±5	25	250	250	5800	0.11	700
CW160808-8N2J	8.2	±5	30	250	250	5000	0.11	700
CW160808-10NJ	10	±5	30	250	250	4800	0.13	700
CW160808-12NJ	12	±5	30	250	250	4000	0.13	700
CW160808-15NJ	15	±5	30	250	250	4000	0.17	700
CW160808-18NJ	18	±5	30	250	250	3100	0.17	700
CW160808-22NJ	22	±5	35	250	250	3000	0.19	700
CW160808-27NJ	27	±5	35	250	250	2800	0.22	600
CW160808-33NJ	33	±5	35	250	250	2300	0.22	600
CW160808-39NJ	39	±5	35	250	250	2200	0.25	600
CW160808-47NJ	47	±5	35	200	250	2100	0.28	600
CW160808-56NJ	56	±5	35	200	250	1900	0.31	600
CW160808-68NJ	68	±5	35	200	250	1700	0.34	600
CW160808-82NJ	82	±5	34	150	250	1700	0.54	400
CW160808-R10J	100	±5	34	150	250	1400	0.71	400
CW160808-R12J	120	±5	32	150	250	1350	0.79	300
CW160808-R15J	150	±5	28	150	150	1300	0.92	280
CW160808-R18J	180	±5	25	100	100	990	1.25	240
CW160808-R22J	220	±5	25	100	100	990	1.90	200
CW160808-R27J	270	±5	25	100	100	990	2.30	170

Packaging Specifications



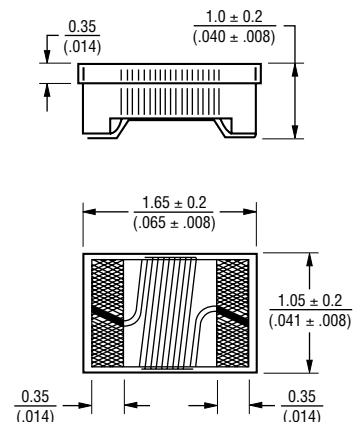
General Specifications

Temperature Rise20 °C max. at rated current
 Operating Temperature-40 °C to +125 °C
 Storage Temperature-40 °C to +125 °C
 Reflow Soldering ...230 °C, 50 sec. max.
 Resistance to Soldering Heat260 °C, 10 seconds

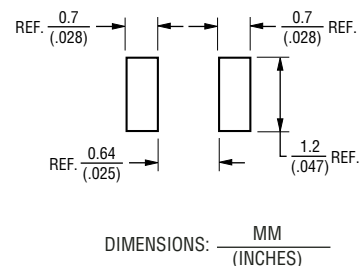
Materials

Core MaterialAlumina
 (1CC150707-302291))
 WireEnamelled Copper (1W1E180)
 Terminal.....Mo/Mn+Ni+Au
 Encapsulate Epoxy (1EAS-UV300)
 Packaging.....3,000 pcs per reel

Product Dimensions



Recommended Layout



REV. 05/05

*RoHS Directive 2002/95/EC Jan 27 2003 including Annex

Specifications are subject to change without notice.

Customers should verify actual device performance in their specific applications.